



- EMS Electronic manufacturing services, A1/B1 PCBs and other circuit carriers
- Electromechanics and system peripherals, Interconnection components
- Electromechanics and system peripherals, Interconnection components, Relays, switches and keyboards
- Electromechanics and system peripherals, Interconnection components, Casing technology
- EMS Electronics manufacturing services, PCBs and other circuit carriers, C<sub>6</sub> Electromechanics and system peripherals
- А3 Test and measurement
- Power supplies
- Passive components
- Sensor technology, Micro- and nanosystems (NEMS, MEMS)
- all halls Embedded systems
- Semiconductors
- Displays
- all halls Automotive
- Wireless
- C1-2 SEMICON Europa 2024
- all halls ED/EDA / Servo-technology / Assemblies and subsystems / Services
- ICM Conferences
  - electronica Automotive Conference
  - Wireless Congress

### **SEMICON Europa Conferences**

- MEMS & Imaging Sensors Summit
- Fab Management Forum (FMF)
- Advanced Packaging Conference (APC)



components I systems I applications I solutions World's leading trade fair and conference for electronics Trade Fair Center Messe München I November 12-15, 2024 electronica.de

### Printed Flectronics by LOPEC & OE-A

- A4: electronica Stage
- Electrical Connectors Measurement Technology

**Components Marketplace** 

PCB, EMS & Components

### **A5: Power Efficiency Stage B4: Visionary Stage** Embedded Systems

Power Electronics

B4: Start-up Stage 🐒

electronica Fast Forward

- Cvber Security
  - Industrial IoT: AI/Machine Learning, 5G & Edge Computing
  - Women in Tech

# **B6: Smart Mobility Stage**

- Automotive
- Printed Electronics by LOPEC & OE-A

## C5: Future Control Stage

- Embedded Platforms
- Industrial Control

# **SEMICON Europa Forums**

- SEMICON Europa TechARENA (C1)
- SEMICON Europa Executive Forum (C2)